ASEDCIATION CONNECTING ELECTRONICS INDUSTRIES® International and	. IPC, Bannockt	ourn, Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declarat he declaration e	ion of the su encompasses	ibstances v s all lower	within the manufactu level materials for w	rer listed i which the n	em. Note: i nanufacture	f the item is an as r has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				ials and M	als and Mfg Information				
upplier Information														
Company name* Com			Company unique ID			Unique ID Authority				Respons	Response Date*			
nsemi										2024-05	2024-05-01			
ontact Name Title - Contact			t			Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product Env			Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Repres			presentative			Phone - Representative*			Email -	Email - Representative*				
Product-Env-Stewards Product			roduct Enviro Compliance			NA				Produc	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item	n Number	Mfr Item Name			Effective Date	Version	Version Manufacturing Site			Weight*	UOM	Unit Type	
	LC79430	LC79430KNE-E LCD Dr		CD Driver ICs		2024-05-01		P	РНМ		1500.0	mg	Each	
Ianufacturing Proccess Inform	nation													
Terminal Plating / Grid Array	g / Grid Array Material Terminal Base		Alloy J-STD-020 MSL Rating		L Rating	Peak Process Body Temperature M		e Max Time at Peak	Time at Peak Temperat		per of Reflow Cyd	cles		
contains Bi CU Alloy		CU Alloy		3		260		С	30	secon	ds 3			
omments														
<b>TTENTION: MSL 3 Rated item requ</b>	ires Bake and D	ry Pack (after	electrical test)											
or more information regarding mater	al composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	5.02	mg	Supplier	Silicon (Si)	7440-21-3		4.9889	mg
			Supplier	Polyimide	Proprietary Data		0.0311	mg
Die Attach	0.41	mg	Supplier	Silver (Ag)	7440-22-4		0.3136	mg
			Supplier	Epoxy resins	129915-35-1		0.0963	mg
Lead Frame	350.5	mg	Supplier	Silver (Ag)	7440-22-4		0.5079	mg
			Supplier	Zinc (Zn)	7440-66-6		0.4374	mg
			Supplier	Iron (Fe)	7439-89-6		8.2248	mg
			Supplier	Copper (Cu)	7440-50-8		341.041	mg
			Supplier	Phosphorus (P)	7723-14-0		0.2888	mg
Mold Compound-Black	1131.53	mg		Brominated epoxy resin	proprietary data		12.4468	mg
			Supplier	Organic Phosphorus compound	Proprietary Data		2.2631	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		104.1008	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		4.5261	mg
			Supplier	Carbon Black (C)	1333-86-4		2.2631	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		970.8528	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		35.0774	mg
Plating	10.65	mg	В	Bismuth (Bi)	7440-69-9		0.0639	mg
			Supplier	Tin (Sn)	7440-31-5		10.5861	mg
Wire Bond - Au	1.89	mg	Supplier	Gold (Au)	7440-57-5		1.89	mg